IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition De © Copyright 2005. IPC, Bannockl international and Pan-American co		burn, Illinois. All rights reserved under both		This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials a	rials and Mfg Information				
uppliei	r Information														
Company name*				Company unique ID			Unique ID Authority				Re	Response Date*			
nsemi										20	2025-07-31				
ontact N	ame	Title - Contact			F	Phone - Contact*				Er	Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance			1	NA				P	Product-Env-Stewards@onsemi.com			
uthorize	d Representative*	Title - Representative			F	Phone - Representative*				Er	Email - Representative*				
Product-Env-Stewards Product Enviro				ro Compliance		NA				P	Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	n I	Manufacturing Site		Weight*	UOM	Unit Type	
		1N4006RLG REC AXIAL 1A		REC AXIAL 1A 8	800V STD TR	TR 2025-07-31		(	CNP		250.82	mg	Each		
lanufa	cturing Process Information		Terminal Base	Alloy	-STD-020 MSI	Pating	Peak Proc	ess Rody '	Temperatu	-a May Time a	t Peak Ten	mperature Number	er of Reflow Cy	cles	
	, , , , , , , , , , , , , , , , , , ,		CU Alloy NA			2 Rating	0	rocess Body Temperature   Max Time at Peak   C   30			seconds 3		cies		
omments	` /		oc may		14.8		10			100	I	beconds			
omnents															
or more	information regarding materia	l composition	please refer to	n nage 3											

<b>RoHS Material Composition Declaration</b>			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of the supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rig											
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature R		,									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.18		Supplier	Silicon (Si)	7440-21-3		0.1682	mg
			В	Nickel (Ni)	7440-02-0		0.0021	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0097	mg
Die Attach Solder	7.98		Supplier	Silver (Ag)	7440-22-4		0.1995	mg
			A	Lead (Pb)	7439-92-1	7a	7.3815	mg
			Supplier	Tin (Sn)	7440-31-5		0.399	mg
Lead Frame	125.08	mg	Supplier	Copper (Cu)	7440-50-8		125.08	mg
Mold Compound-Black	116.8			Metal Hydroxide	proprietary data		5.84	mg
			Supplier	Carbon Black (C)	1333-86-4		1.168	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		87.6	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		11.68	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		10.512	mg
Plating	0.78	mg	Supplier	Tin (Sn)	7440-31-5		0.78	mg